

Electronic Supplementary Information (ESI) for Sputtering MoO₂ blocking layer for enhancing the efficiency and dynamic response of CZTSSe solar cells

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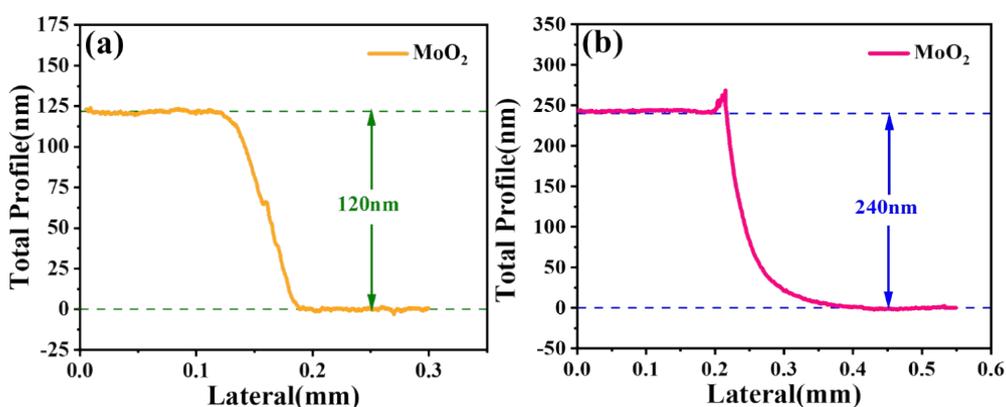


Fig.S1. Profilometer measurement of MoO₂ films with two sputtering times: (a) 2 hours; (b) 4 hours

To ensure precise thickness control of sputtered MoO₂ films, optimizing the sputtering parameters is critical. A common lab method involves sputtering thicker films to explore these parameters. Under room temperature, 0.38 Pa argon atmosphere, and 120 W RF power, MoO₂ was sputtered for 2 hours and 4 hours, respectively. The thicknesses measured by the stylus profiler are 120 nm and 240 nm (as shown in Fig.S1(a) and (b)), with clear step edges. This results in a deposition rate of 1 nm/min under these parameters, providing strong data support for subsequent exploration of optimal thickness for blocking layer.

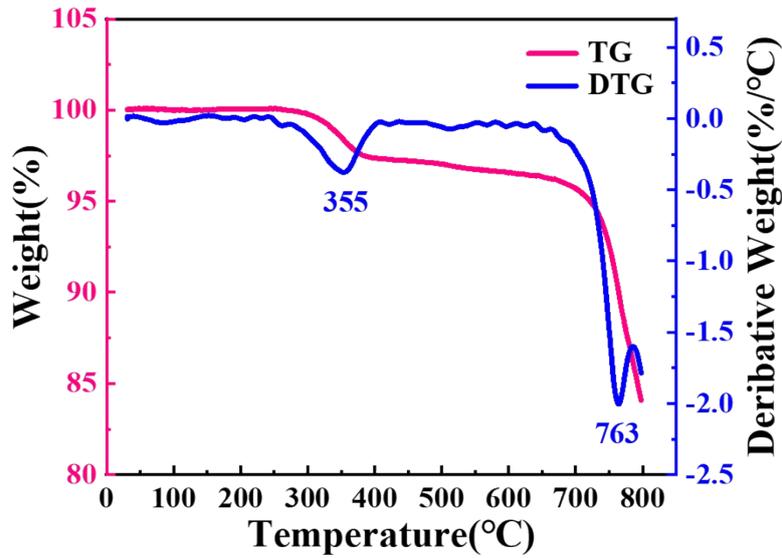
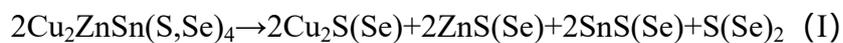


Fig. S2. The TG and DTG curves of CZTSSe powder

To study the thermal stability of the absorber layer film, we prepared SLG\CZTSSe sample and scraped off powder to characterize its TG and DTG properties. As shown in Fig. S2, the CZTSSe powder exhibited an initial weight loss of approximately 3% at around 355°C. This may be attributed to the volatilization of excess sulfur atoms (sulfur interstitials, S_i) in kesterite (chemical formula $Cu_2ZnSn(S,Se)_4$) under low saturated vapor pressure. This is contrary to the high-temperature or high vapor pressure conditions (which suppress sulfur volatilization) used in the preparation of $Cu_2ZnSn(S,Se)_4$. Under low saturated vapor pressure conditions, sulfur atoms are more likely to escape from the lattice (volatilization), leading to the formation of sulfur vacancy defects. In the temperature range of 380-700°C, the weight loss of the CZTSSe powder was relatively slow, corresponding to the decomposition reaction and volatilization of sulfur (selenium) molecules as described by Equation (I). In the range of 700-800°C, the CZTSSe powder experienced a sharp weight loss, at which point $SnS(Se)$ also began to volatilize¹.



The above TG and DTG tests indicate: (1) The adsorption of sulfur (selenium) molecules and the formation of polycrystalline in the CZTSSe absorber layer begin at approximately 355°C; (2) during the sputtering of the window layer (ZnO and ITO) or overall device air-annealing, a substrate temperature can be applied, but it should not exceed 300°C, otherwise it will lead to sulfur element volatilization and an increase in the back interface $Mo(S,Se)_2$ layer thickness.

Although the powder scraped from the SLG\CZTSSe sample does not fully represent a reliable thermogravimetric measurement of the entire CZTSSe device due to practical

limitations, the thermal decomposition behavior observed in the powder still provides important insights into the stability of the CZTSSe material system. The volatilization of sulfur species and decomposition reactions identified through powder analysis are intrinsic characteristics of the CZTSSe compound, and under similar thermal conditions, these processes can reasonably be expected to occur in the thin-film form as well. We will also explicitly connect these findings to device processing considerations, particularly regarding the maximum allowable temperature ($<300^{\circ}\text{C}$) during window layer (ZnO and ITO) sputtering or overall device air-annealing, to prevent sulfur loss and excessive $\text{Mo}(\text{S},\text{Se})_2$ formation at the back contact, which directly impacts device performance and long-term stability.

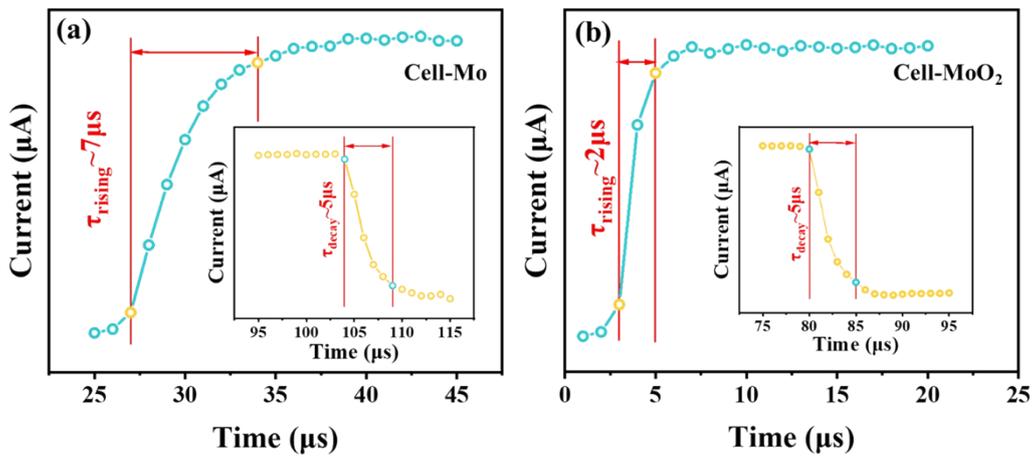


Fig. S3. *I-T* curves of the rising edge and falling edge for the two devices under 10 kHz, 70% duty cycle laser pulse excitation: (a) Cell-Mo; (b) Cell-MoO₂

As shown in Fig. S3, the time response characteristics of the two devices are described. The pulse rise time (τ_{rising}) of Cell-MoO₂ is 2 μs , much lower than that of Cell-Mo (7 μs), indicating its faster capture of optical signal changes. The pulse fall time (τ_{decay}) of both devices is 5 μs , suggesting comparable performance during signal decay.

The difference in light response capability indicates that the Cell-MoO₂ device may have superior carrier mobility, enabling rapid accumulation of photogenerated carriers under pulse excitation and thus enhancing the peak photocurrent. The short τ_{rising} of Cell-MoO₂ is attributed to its fewer interface trap states and higher carrier injection efficiency, while the longer τ_{rising} of Cell-Mo may arise from interface recombination losses².

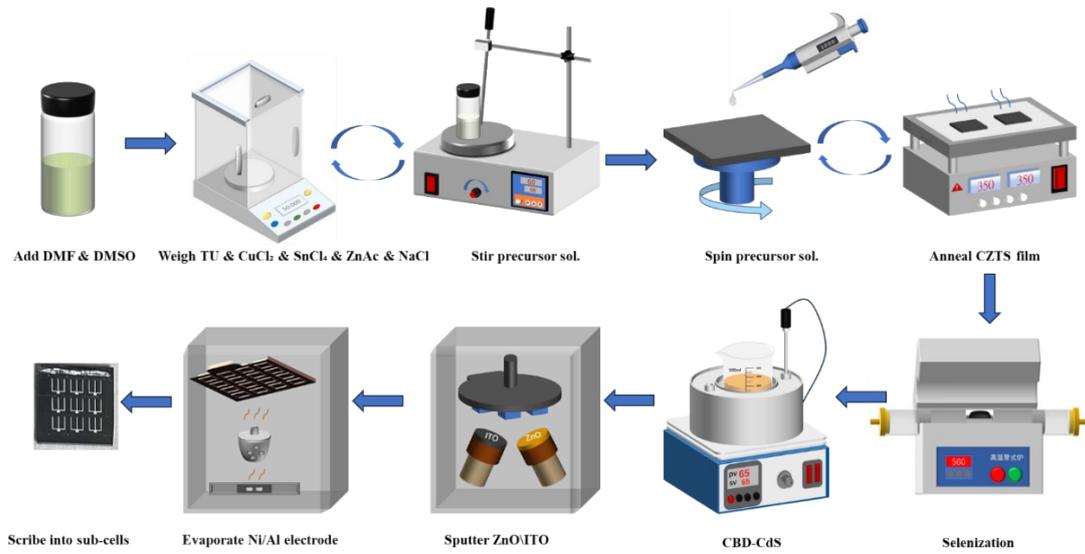


Fig. S4. Fabrication Process Flow of CZTSSe Solar Cells

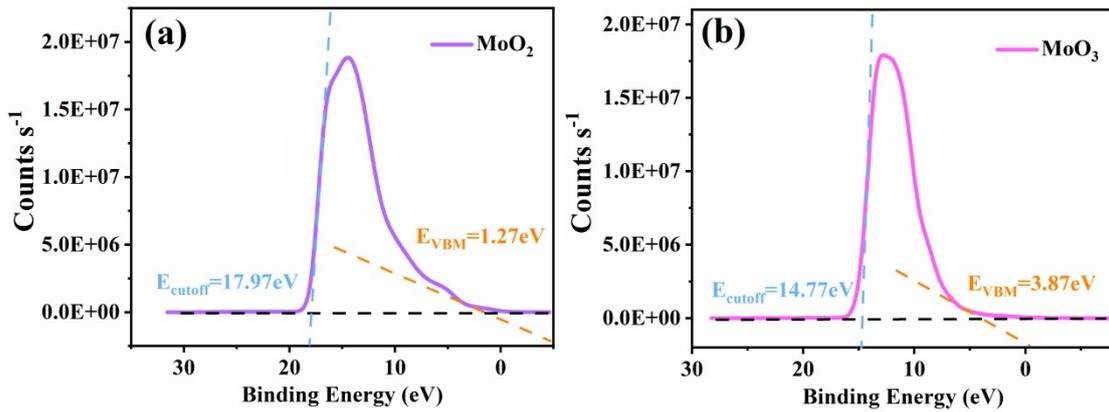


Fig. S5. UPS fitting plots for (a) MoO₂ sample; (b) MoO₃ sample

Annealing at 350 °C for 10 minutes promotes the oxidation of Mo⁴⁺ to Mo⁶⁺ by reducing oxygen vacancies (O_{vac}) and increasing lattice oxygen (O_{lat}) content, which could indeed significantly affect the surface electronic structure and band alignment. To verify this hypothesis, we performed UPS measurements on the MoO₂ sample (structure: SLG\Mo\MoO₂) and the MoO₃ sample (structure: SLG\Mo\MoO₃).

UPS measurements were performed on an ESCALAB 250Xi X-ray photoelectron spectrometer equipped with a He discharge lamp. The typical base pressure in the spectrometer chamber was 2×10^{-10} Pa. The UPS spectra were recorded using unfiltered He I (21.22 eV) excitation, with a bias of -5.00 V applied to the samples to observe the low-energy secondary electron cutoff. The UV spot size on the samples was approximately 600

μm in diameter. The typical instrument resolution for UPS measurements was 0.05 eV, with a photon energy dispersion of less than 20 meV.

As shown in Fig. S5, the cutoff binding energy measured on the MoO_2 surface is 17.97 eV, from which the work function is derived to be 3.25 eV by subtracting the photon energy of 21.22 eV. For the MoO_2 film, $E_f - E_{\text{VBM}} = 1.27$ eV, where E_f is the Fermi level and E_{VBM} is the valence band maximum. For the MoO_3 surface, the measured cutoff binding energy is 14.77 eV, yielding a work function of 6.45 eV after subtracting the photon energy of 21.22 eV. The $E_f - E_{\text{VBM}}$ value for the MoO_3 film is 3.87 eV. Based on these data, the ionization potentials (IP) of the MoO_2 and MoO_3 films are calculated to be 4.52 eV and 10.32 eV, respectively. Detailed parameters are provided in Table S1.

MoO_3 exhibits a high work function (6.45 eV), characteristic of a typical wide-bandgap n-type oxide semiconductor. MoO_2 has a low work function (3.25 eV), suggesting it behaves as a metallic-like narrow-bandgap n-type oxide semiconductor³. However, it should be noted that in the MoO_2 sample (structure: SLG/Mo/MoO₂) and the MoO_3 sample (structure: SLG/Mo/MoO₃), the MoO_2 and MoO_3 blocking layers serve as a sacrificial barrier. Specifically, during high-temperature selenization annealing at 560 °C, both MoO_2 and MoO_3 disappear (are sacrificed) and transform into MoSe_2 . After selenization, the absorber layer sample structure becomes SLG/Mo/MoSe₂/CZTSSe, and the final device structure is SLG/Mo/MoSe₂/CZTSSe/CdS/ZnO/ITO, where no blocking layer (MoO_2 or MoO_3) remains. The purpose of introducing this blocking layer is to suppress the reaction between Mo and Se vapor under low-temperature conditions, thereby reducing the thickness of the MoSe_2 layer.

Table S1. Fitted valence band parameters of MoO_2 and MoO_3 samples, where $E_{\text{cutoff, B.E.}}$ (eV) is the binding energy of the secondary electron cutoff, $h\nu$ is the excited He I spectral line, Φ represents the work function, E_f is the Fermi level, E_{VBM} is the valence band maximum energy, IP represents the ionization potential ($E_{\text{vac}} - E_{\text{VBM}}$), and E_{vac} represents the vacuum level.

Sample	$E_{\text{cutoff, B.E.}}$ (eV)	$h\nu$ (eV)	Φ (eV)	$E_f - E_{\text{VBM}}$ (eV)	IP (eV)
MoO_2	17.97	21.22	3.25	1.27	4.52
MoO_3	14.77	21.22	6.45	3.87	10.32

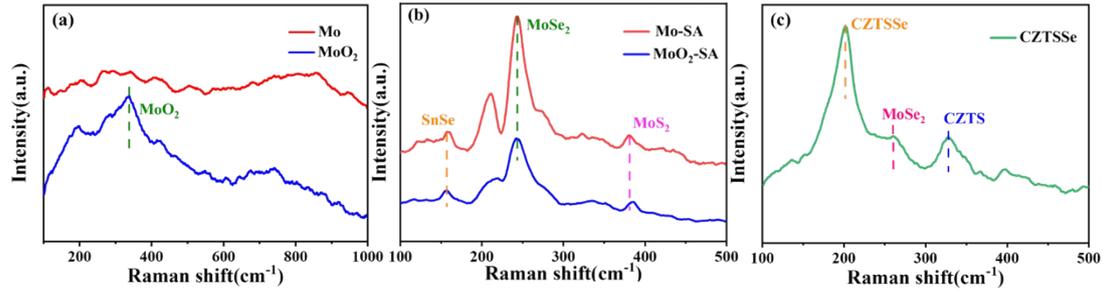


Fig.S6. Raman spectra of (a) Mo and MoO₂ samples; (b) Mo-SA and MoO₂-SA samples after selenization annealing; (c) CZTSSe absorber samples.

To verify that the introduction of a MoO₂ blocking layer can effectively suppress the formation of MoSe₂, Raman spectroscopy was performed on commercial Mo-coated glass (SLG\Mo) and a sample with an additional sputtered MoO₂ layer (SLG\Mo\200nm MoO₂). As shown in Fig. S6(a), the commercial Mo substrate shows no obvious Raman features. In contrast, the prepared MoO₂ sample exhibits a prominent peak at 326 cm⁻¹, characteristic of MoO₂, confirming the successful preparation of the designed blocking layer.

The Mo and MoO₂ samples were converted into Mo-SA and MoO₂-SA samples, respectively, after selenization annealing. As shown in Fig. S6(b), both the Mo-SA and MoO₂-SA samples exhibit peaks corresponding to MoSe₂ (250 cm⁻¹), MoS₂ (383 cm⁻¹), and SnSe (156 cm⁻¹). These peaks originate from chemical reactions between the Mo-based layers and the Se and S vapors generated from the Se and SnS powders added into the graphite box at high temperatures. A detailed comparison reveals that the intensity of the MoSe₂ peak for the MoO₂-SA sample is significantly lower than that for the Mo-SA sample, indicating that the MoO₂ layer effectively suppresses the formation of MoSe₂.

We scratched off a portion of the absorber film (SLG\Mo\MoSe₂\CZTSSe), formed by selenizing a precursor with the structure SLG\Mo\10nm MoO₂\CZTS, for Raman measurement. Apart from the CZTSSe peak (196 cm⁻¹), MoSe₂ peak (250 cm⁻¹), and CZTS peak (338 cm⁻¹), no MoO₂ Raman peak was detected. Conversely, as shown in Fig. 9(d), the chemically formed MoSe₂ layer at the back interface of Cell-MoO₂ has a thickness of 300 nm. This further confirms that at a high temperature of 560 °C, the 10 nm MoO₂ layer completely reacts with Se and transforms into MoSe₂, indicating the absence of MoO₂ in the back interface structure of Cell-MoO₂. Consequently, the back interface structures (band-alignment structures) of both Cell-Mo and Cell-MoO₂ are SLG\Mo\MoSe₂\CZTSSe, with the distinction that the Cell-MoO₂ back interface achieves a relatively thinner MoSe₂ layer (300 nm) through the consumption of the MoO₂ layer.

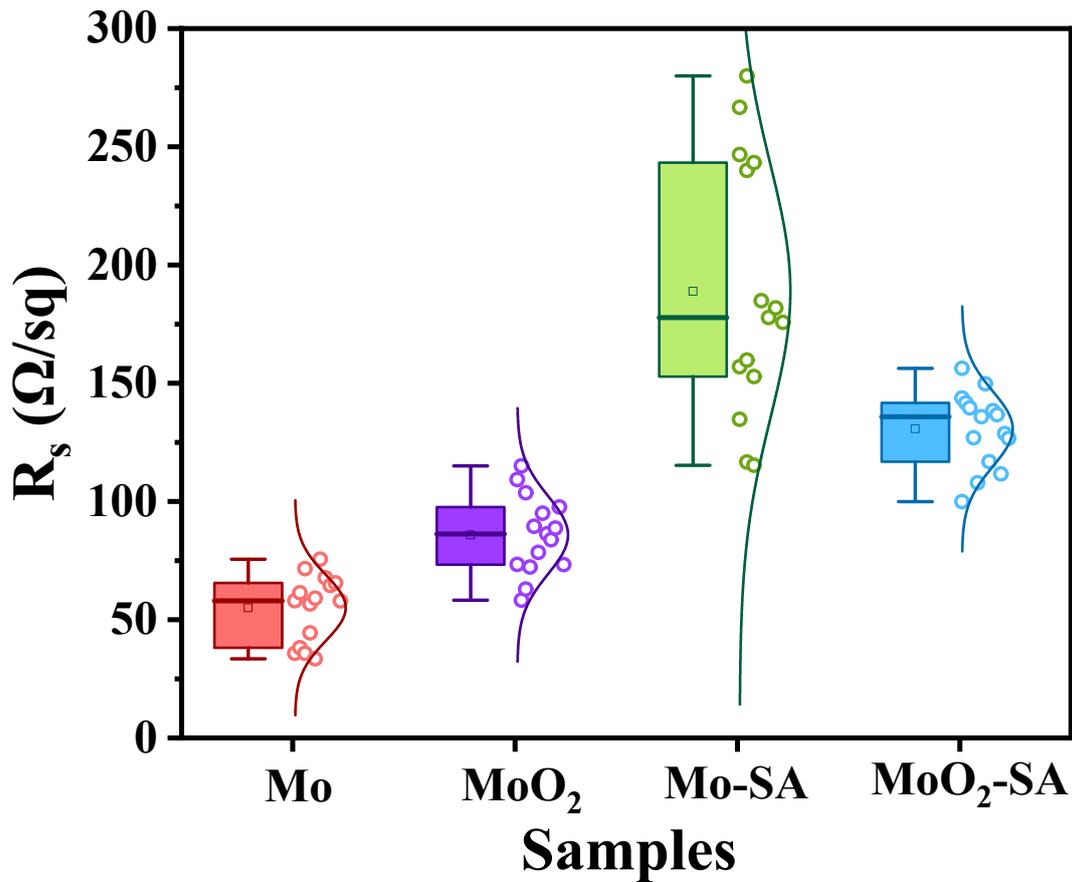


Fig. S7. Sheet resistance statistics of Mo, MoO₂, Mo-SA, and MoO₂-SA samples, with 15 devices per condition and 50 devices total, to validate reproducibility.

To investigate the effect of the MoO₂ blocking layer on electrical performance, we measured the sheet resistance of as-deposited Mo and MoO₂ samples prior to selenization. As shown in Fig. S7, the statistics are based on 15 samples per condition. The pristine Mo samples exhibited a sheet resistance of $55 \pm 14 \Omega$, while the MoO₂-coated samples showed a higher average value of $86 \pm 16 \Omega$. The relatively low standard deviations indicate good film uniformity for both types of samples.

The significant reduction in sheet resistance from $189 \pm 54 \Omega$ for the Mo-SA sample to $131 \pm 16 \Omega$ for the MoO₂-SA sample after selenization can be attributed to the controlled growth of the MoSe₂ interlayer. The MoO₂ layer acts as a sacrificial barrier, limiting the reaction with Se vapor and resulting in a thinner and more uniform MoSe₂ layer compared to the thick, irregular MoSe₂ formed on the bare Mo substrate. The reduced standard deviation further confirms the enhanced uniformity and reproducibility of the back contact achieved with the MoO₂ blocking layer. This improvement is crucial for reducing the series resistance in complete devices, thereby potentially enhancing the short-circuit current density, fill factor, and overall performance of CZTSSe solar cells.

Notes and references

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